

## HMC508LP5 / 508LP5E

v04.0811



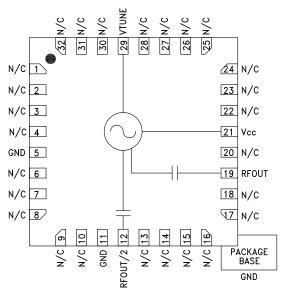
## MMIC VCO w/ HALF FREQUENCY OUTPUT 7.3 - 8.2 GHz

#### **Typical Applications**

Low noise MMIC VCO w/Half Frequency, for:

- VSAT Radio
- Point to Point/Multi-Point Radio
- Test Equipment & Industrial Controls
- Military End-Use

#### **Functional Diagram**



#### **Features**

Dual Output: Fo = 7.3 - 8.2 GHz

Fo/2 = 3.65 - 4.1 GHz

Pout: +15.0 dBm

Phase Noise: -116 dBc/Hz @100 kHz Typ.

No External Resonator Needed

32 Lead 5x5mm SMT Package: 25mm<sup>2</sup>

#### **General Description**

The HMC508LP5 & HMC508LP5E are GaAs InGaP Heterojunction Bipolar Transistor (HBT) MMIC VCOs. The HMC508LP5 & HMC508LP5E integrate resonators, negative resistance devices, varactor diodes and feature a half frequency output. The VCO's phase noise performance is excellent over temperature, shock, and process due to the oscillator's monolithic structure. Power output is +15 dBm typical from a +5V supply. The voltage controlled oscillator is packaged in a leadless QFN 5x5 mm surface mount package, and requires no external matching components.

## Electrical Specifications, $T_A = +25^{\circ}$ C, Vcc = +5V

Parameter		Min.	Тур.	Max.	Units
Frequency Range	Fo Fo/2		7.3 - 8.2 3.65 - 4.1		GHz GHz
Power Output	RFOUT/2	+12 +4		+17 +10	dBm dBm
SSB Phase Noise @ 100 kHz Offset, Vtune= +5V @ RFOUT			-116		dBc/Hz
Tune Voltage	Vtune	2		13	V
Supply Current (Icc) (Vcc = +5.0V)		200	240	280	mA
Tune Port Leakage Current (Vtune= 13V)				10	μA
Output Return Loss			2		dB
Harmonics/Subharmonics	1/2 2nd 3rd		40 20 35		dBc dBc dBc
Pulling (into a 2.0:1 VSWR)			8		MHz pp
Pushing @ Vtune= 5V			10		MHz/V
Frequency Drift Rate		_	1.0		MHz/°C

## **HMC508\* PRODUCT PAGE QUICK LINKS**

Last Content Update: 02/23/2017

## COMPARABLE PARTS -

View a parametric search of comparable parts.

### **EVALUATION KITS**

• HMC508LP5 Evaluation Board.

## **DOCUMENTATION**

#### **Data Sheet**

• HMC508 Data Sheet

### REFERENCE MATERIALS •

#### **Quality Documentation**

- Package/Assembly Qualification Test Report: 32L 5x5mm QFN Package (QTR: 10009 REV: 05)
- Package/Assembly Qualification Test Report: LP3, LP4, LP5 & LP5G (QTR: 2014-00145)
- Package/Assembly Qualification Test Report: Plastic Encapsulated QFN (QTR: 05006 REV: 02)
- Semiconductor Qualification Test Report: GaAs HBT-A (QTR: 2013-00228)

#### **Technical Articles**

 High Performance SiGe PLLs Pair with Low Phase Noise GaAs VCOs for Microwave Radio

## **DESIGN RESOURCES**

- HMC508 Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- Symbols and Footprints

### **DISCUSSIONS**

View all HMC508 EngineerZone Discussions.

## SAMPLE AND BUY 🖵

Visit the product page to see pricing options.

## **TECHNICAL SUPPORT**

Submit a technical question or find your regional support number.

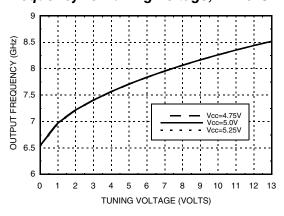
### DOCUMENT FEEDBACK $\Box$

Submit feedback for this data sheet.

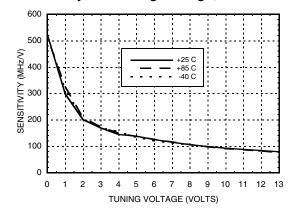




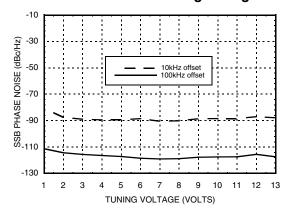
#### Frequency vs. Tuning Voltage, T= 25°C



## Sensitivity vs. Tuning Voltage, Vcc= +5V

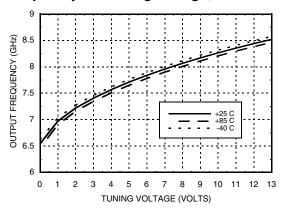


#### SSB Phase Noise vs. Tuning Voltage

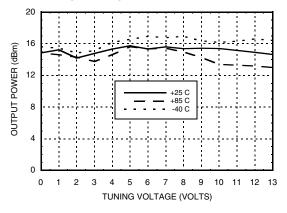


## MMIC VCO w/ HALF FREQUENCY OUTPUT 7.3 - 8.2 GHz

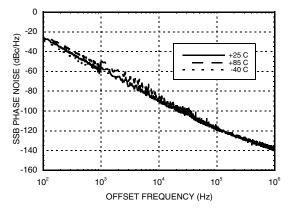
#### Frequency vs. Tuning Voltage, Vcc= +5V



# Output Power vs. Tuning Voltage, Vcc= +5V



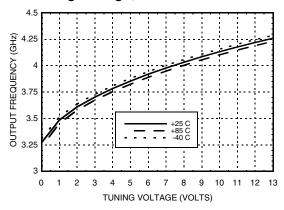
#### SSB Phase Noise @ Vtune = +5V





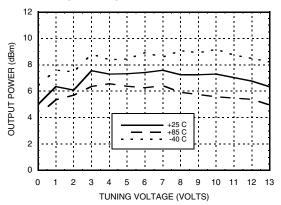


## RFOUT/2 Frequency vs. Tuning Voltage, Vcc= +5V



## MMIC VCO w/ HALF FREQUENCY OUTPUT 7.3 - 8.2 GHz

## RFOUT/2 Output Power vs. Tuning Voltage, Vcc= +5V



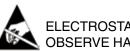
#### **Absolute Maximum Ratings**

Vcc	+5.5 Vdc
Vtune	0 to +15V
Junction Temperature	135 °C
Continuous Pdiss (T=85 °C) (derate 28 mW/C above 85 °C	1.4 W
Thermal Resistance (junction to ground paddle)	35 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A

### Typical Supply Current vs. Vcc

Vcc (V)	Icc (mA)
4.75	220
5.0	240
5.25	260

Note: VCO will operate over full voltage range shown above.



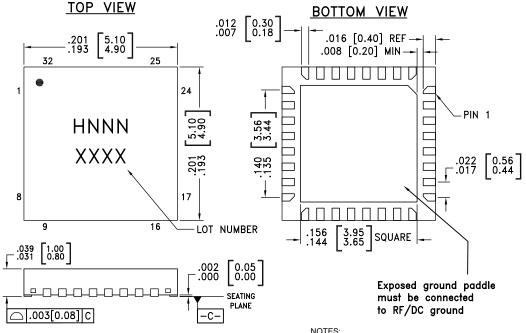
ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS





## MMIC VCO w/ HALF FREQUENCY **OUTPUT 7.3 - 8.2 GHz**

#### **Outline Drawing**



- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM. PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

#### Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC508LP5	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL3 [1]	H508 XXXX
HMC508LP5E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL3 <sup>[2]</sup>	H508 XXXX

- [1] Max peak reflow temperature of 235  $^{\circ}\text{C}$
- [2] Max peak reflow temperature of 260 °C
- [3] 4-Digit lot number XXXX





## MMIC VCO w/ HALF FREQUENCY OUTPUT 7.3 - 8.2 GHz

#### **Pin Descriptions**

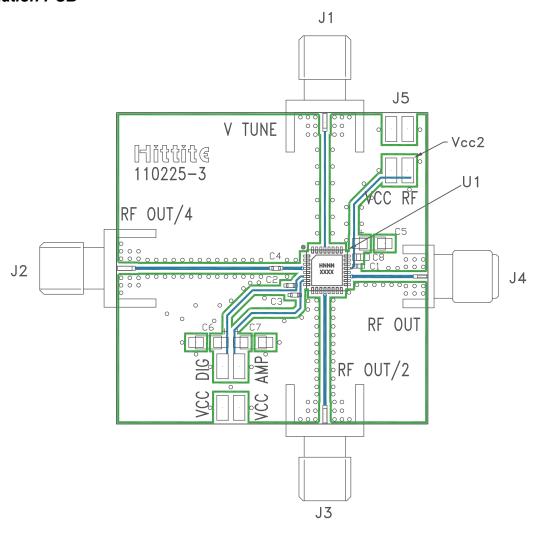
Pin Number	Function	Description	Interface Schematic
1 - 4, 6 - 10, 13 - 18, 20, 22 - 28, 30 - 32	N/C	No Connection. These pins may be connected to RF/ DC ground. Performance will not be affected.	
12	RFOUT/2	Half frequency output (AC coupled).	→ PRFOUT/2
19	RFOUT	RF output (AC coupled).	RFOUT
21	Vcc	Supply Voltage, +5V	VccO14pF
29	VTUNE	Control Voltage Input. Modulation port bandwidth dependent on drive source impedance.	VTUNEO 200 3nH 4pF 75pF
5, 11, Paddle	GND	Package bottom has an exposed metal paddle that must be connected to RF/DC ground.	GND





## MMIC VCO w/ HALF FREQUENCY OUTPUT 7.3 - 8.2 GHz

#### **Evaluation PCB**



#### List of Materials for Evaluation PCB 110227 [1]

Item	Description	
J1 - J4	PCB Mount SMA RF Connector	
J5	2 mm DC Header	
C1 - C3	100 pF Capacitor, 0402 Pkg.	
C4	1,000 pF Capacitor, 0402 Pkg.	
C5 - C7	2.2 µF Tantalum Capacitor	
U1	HMC508LP5(E) VCO	
PCB [2]	110225 Eval Board	

<sup>[1]</sup> Reference this number when ordering complete evaluation PCB

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and backside ground paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

<sup>[2]</sup> Circuit Board Material: Arlon 25FR